MA3Z080D, MA3Z080E (MA80WA, MA80WK)

Silicon epitaxial planar type

For band switching

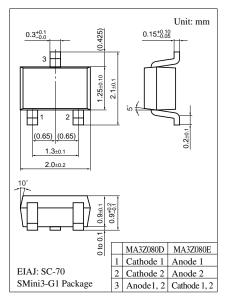
Features

- Low forward dynamic resistance r_f
- Less voltage dependence of diode capacity C_D
- S-Mini type package, allowing downsizing of equipment and automatic insertion through the taping package

Absolute Maximum Ratings $T_a = 25^{\circ}C$

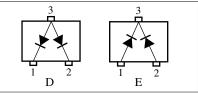
Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	V _R	35	V
Forward current (DC)	I_F	100	mA
Operating ambient temperature *	T _{opr}	-25 to +85	°C
Storage temperature	T _{stg}	-55 to +150	°C

Note) *: Maximum ambient temperature during operation



Marking Symbol • MA3Z080D: M1X • MA3Z080E: M1Y

Internal Connection



Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	I _R	$V_R = 33 V$		0.01	100	nA
Forward voltage (DC)	V _F	$I_F = 100 \text{ mA}$		0.92	1.0	v
Diode capacitance	CD	$V_R = 6 V, f = 1 MHz$		0.9	1.2	pF
Forward dynamic resistance *	r _f	$I_F = 2 \text{ mA}, \text{ f} = 100 \text{ MHz}$		0.65	0.85	Ω

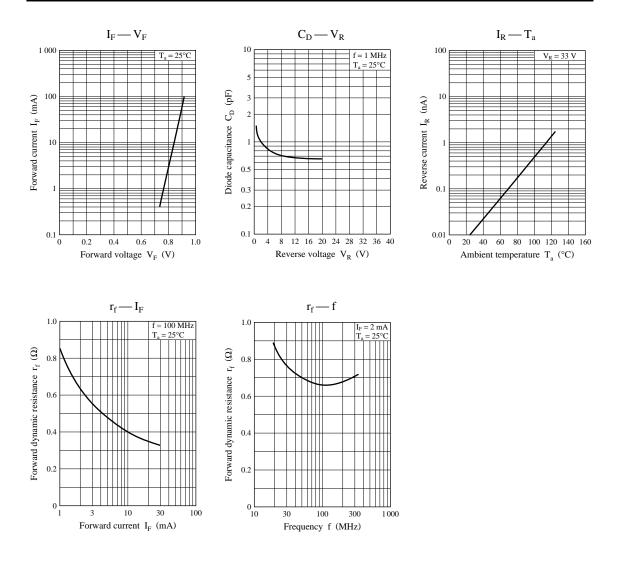
Electrical Characteristics $T_a = 25^{\circ}C$

Note) 1. Each characteristic is a standard for individual diode

2. Rated input/output frequency: 100 MHz

3. *: Measuring instrument; YHP MODEL 4191A RF IMPEDANCE ANALYZER

Note) The part number in the parenthesis shows conventional part number.



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